Atty Docket No.: 294092US8 JAN 08 2007 BY ACCORDATION PATEN

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the Director of the United States Patent and Trademark Office. Please record the attached of

To the Director of the United States Patent and Trademark Office. Please record the attached original documents or copy thereof. 2. Name and address of receiving party(ies): 1. Name of conveying party(ies): Tatsuya KONNO, Susumu TAKATSUKA, Hideo TSUKAZAKI, SONY CORPORATION Name: Takashi KINOUCHI, Kotaro ASAKA, Takashi KAWAKAMI, Address: 7-35 Kitashinagawa 6-Chome, Shingawa-Ku, Yasuharu SEKI Tokyo, Japan Additional name(s) of conveying party(ies) attached?

Yes No 3. Nature of Conveyance: ☐ Merger Assignment ☐ Change of Name ☐ Security Agreement ☐ Other Execution Date: November 26, 10, December 12, Additional name(s) and address(es) attached? 🗆 Yes 🔳 No November 10, 10, 21, 10, 2006 4. Application number(s) or patent number(s): ☐ This document is being filed together with a new application B. Patent No.(s) A. Patent Application No.(s) 11/492,116 Additional numbers attached?

Yes No 5. Name and address of party to whom correspondence 6. Total applications and patents involved: 1 concerning document should be mailed: 7. Total fee (37 CFR 3.41): \$40.00 Customer Number Enclosed ☐ Authorized to be charged to deposit account Tel. (703) 413-3000 8. Deposit account number: 15-0030 Fax. (703) 413-2220 (Attach duplicate copy of this page if paying by deposit account) DO NOT USE THIS SPACE 9. Statement and signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Bradley D. Lytle Name of Person Signing Joseph Scafetta, Jr. Registration Number: 40,073 Registration No. 26,803 Total number of pages including this cover sheet: 4 Do not detach this portion Mail documents to be recorded with required cover sheet information to:

Director of the United States Patent and Trademarks Patent and Trademarks Patent Paten

PATENT REEL: 018775 FRAME: 0685

Docket Number:
ASSIGNMENT
WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in INFORMATION-PROCESSING APPARATUS, REPRODUCTION APPARATUS, COMMUNICATION METHOD AND COMPUTER PROGRAM
for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;
AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;
NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;
And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;
And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;
And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;
And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.
And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 11/492,116 Filing Date: July 25, 2006
This assignment executed on the dates indicated below.

Tatsuya KONNO

Tokyo, Japan

Name of first or sole inventor

Residence of first or sole inventor

Signature of first or sole inventor

PATENT REEL: 018775 FRAME: 0686

Execution date of U.S. Patent Application

Date of this assignment

Execution date of U.S. Patent Application
10. Nov. '06 Date of this assignment
Date of this assignment
Execution date of U.S. Patent Application
Dec. 12. 2006
Date of this assignment
Execution date of U.S. Patent Application
Nov 10 7006
Nov. 10, 2006 Date of this assignment
Execution date of U.S. Patent Application
Nov. 10, 2006
Date of this assignment

PATENT REEL: 018775 FRAME: 0687

Takashi KAWAKAMI	
Name of sixth inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of sixth inventor	
The W	Nev. 21 200 £
Signature of sixth inventor	Date of this assignment
Yasuharu SEKI	
Name of seventh inventor	Execution date of U.S. Patent Application
Chiba, Japan Residence of seventh inventor	
Gaenhary Sek	1/2 / 2 2 2 7
Signature of seventh inventor	Nov. 10. 200 6 Date of this assignment
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Signature of eighth inventor	Date of this assignment
Name of ninth inventor	Execution date of U.S. Patent Application
Residence of ninth inventor	
Signature of ninth inventor	Date of this assignment

PATENT REEL: 018775 FRAME: 0688

RECORDED: 01/08/2007